

### Description

The AONR36368-HXY uses advanced trench technology

to provide excellent  $R_{\text{DS}(\text{ON})},$  low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

### **General Features**

V<sub>DS</sub> = 30V I<sub>D</sub> =60 A

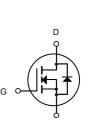
 $R_{DS(ON)} < 8 \, m\Omega$  @ V<sub>GS</sub>=10V

#### Application

Battery protection

Load switch Uninterruptible power supply

#### Package Marking and Ordering Information



Pin 1

DFN3X3-8L

N-Channel MOSFET

Product ID	Pack	Marking	Qty(PCS)
AONR36368-HXY	DFN3X3-8L	60N03 XXX YYYY	5000

### Absolute Maximum Ratings (TC=25°C unless otherwise specified)

Symbol	Parameter	Rating	Units	
VDS	Drain-Source Voltage	30	V	
Vgs	Gate-Source Voltage	±20	V	
I <sub>D</sub> @Tc=25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	60	А	
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	20	А	
I <sub>D</sub> @T <sub>A</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	15	А	
I <sub>D</sub> @T <sub>A</sub> =70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	12	А	
Ілм	Pulsed Drain Current <sup>2</sup>	140	А	
EAS	Single Pulse Avalanche Energy <sup>3</sup>	115.2	mJ	
las	Avalanche Current	48	А	
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	59	W	
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation <sup>4</sup>	2	W	
Тята	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range -55 to 150		°C	
Reja	Thermal Resistance Junction-ambient <sup>1</sup>	Thermal Resistance Junction-ambient <sup>1</sup> 62		
Rejc	Thermal Resistance Junction-Case <sup>1</sup>	2.1	°C/W	



# AONR36368-HXY

N-Channel Enhancement Mode MOSFET

## Electrical Characteristics (TJ=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
	Voltage			0.007		
$\triangle BV$ DSS/ $\triangle T_J$	BVDSS Temperature Coefficient	Reference to 25°C,		0.027		V/°C
	Coefficient	$I_D=1mA$		6	0	
		V <sub>GS</sub> =10V , I <sub>D</sub> =20A			8	
Rds(on)	Static Drain-Source On-	V <sub>GS</sub> =4.5V , I <sub>D</sub> =10A		7.5	10	mΩ
V <sub>GS</sub> (th)	Resistance <sup>2</sup> Gate Threshold Voltage		1.2		2.5	V
	Ĵ	_	1.2		2.5	
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_{D}=250 uA$		-5.8		mV/°C
		V <sub>DS</sub> =24V , V <sub>GS</sub> =0V ,			1	
DSS	Drain-Source Leakage Current	T <sub>J</sub> =25°C				uA
		V <sub>DS</sub> =24V,V <sub>GS</sub> =0V, T」=55°C			5	
Igss	Gate-Source Leakage Current	-			±100	nA
		V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =30A		43		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.7		Ω
Qg	Total Gate Charge (4.5V)	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V ,		20		nC
Qgs	Gate-Source Charge			7.6		
$Q_{gd}$	Gate-Drain Charge	_I <sub>D</sub> =15A		7.2		
Td(on)	Turn-On Delay Time			7.8		ns
Tr	Rise Time	−V <sub>DD</sub> =15V , V <sub>GS</sub> =10V , R <sub>G</sub> =3.3Ω		15		
Td(off)	Turn-Off Delay Time	-RG-3.3Ω -ID=15A		37.3		
T <sub>f</sub>	Fall Time			10.6		
Ciss	Input Capacitance			2295		pF
Coss	Output Capacitance	V <sub>DS</sub> =15V,V <sub>GS</sub> =0V, f=1MHz		267		
Crss	Reverse Transfer Capacitance			210		
ls	Continuous Source Current <sup>1,6</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force			40	А
lsм	Pulsed Source Current <sup>2,6</sup>	Current			140	А
Vsd	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V,I <sub>S</sub> =1A, TJ=25°C			1	V

**Diode Characteristics** 

Note : 1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

3 .The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, \text{L=}0.1\text{mH}, I_{\text{AS}}\text{=}34\text{A}$ 

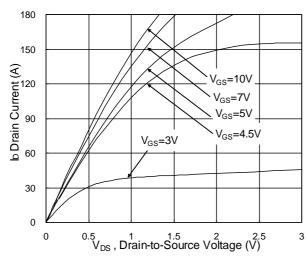
4.The power dissipation is limited by 150  $^\circ\text{C}$  junction temperature

5 .The data is theoretically the same as  $I_{\text{D}}$  and  $I_{\text{DM}}$  , in real applications , should be limited by total power dissipation.



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### **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

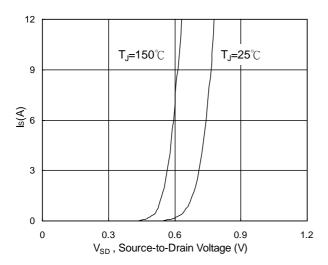


Fig.3 Forward Characteristics of Reverse

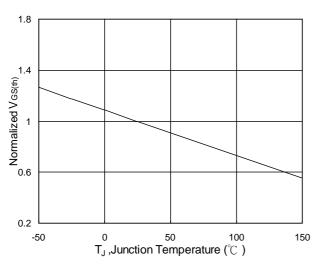


Fig.5 Normalized  $V_{\text{GS(th)}}\,vs.\,T_J$ 

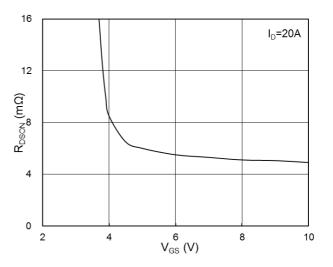


Fig.2 On-Resistance vs. G-S Voltage

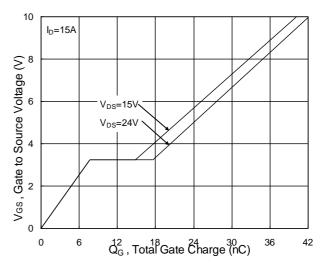


Fig.4 Gate-Charge Characteristics

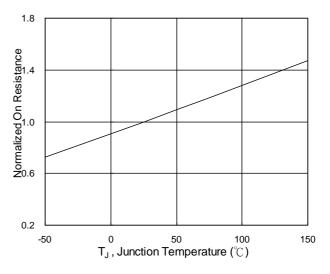


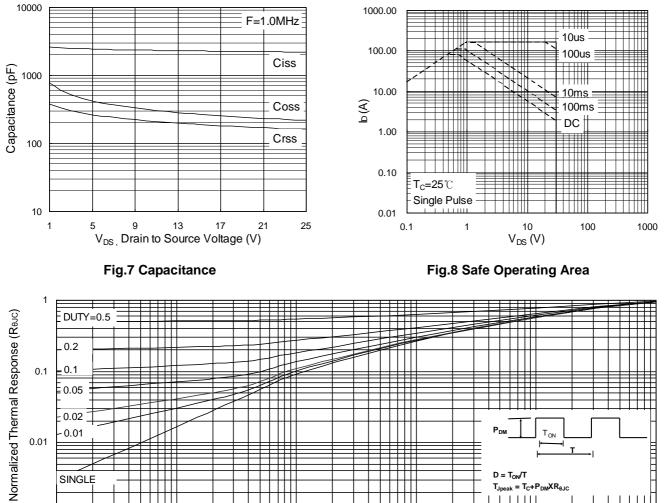
Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>

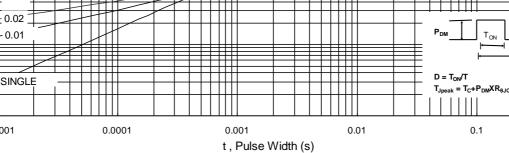


0.01

0.001 0.00001

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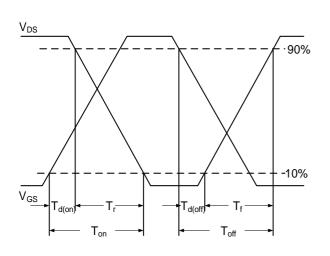


Fig.10 Switching Time Waveform

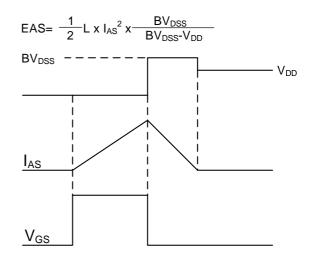
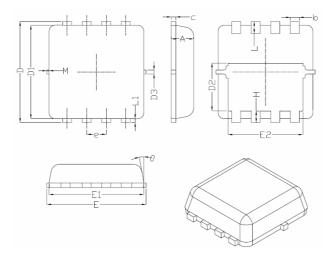


Fig.11 Unclamped Inductive Switching Waveform

1



### DFN3X3-8L Package Information



	Dimensions In Millimeters			
Symbol	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
С	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
е	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
М	*	*	0.15	
θ		10 <sup>°</sup>	12 <sup>°</sup>	



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